# SOT1699-1

QFP64, plastic, quad flat package; 64 terminals; 0.5 mm pitch; 10 mm x 10 mm x 1.4 mm body

30 July 2018

Package information

Package information

#### **Package summary** 1

Terminal position code Q (quad) QFP64 Package type descriptive code

Package style descriptive code QFP (quad flat package)

Package body material type P (plastic) JEDEC package outline code MS-026 BCD Mounting method type S (surface mount)

Issue date 25-01-2016 Manufacturer package code 98ASS23234W

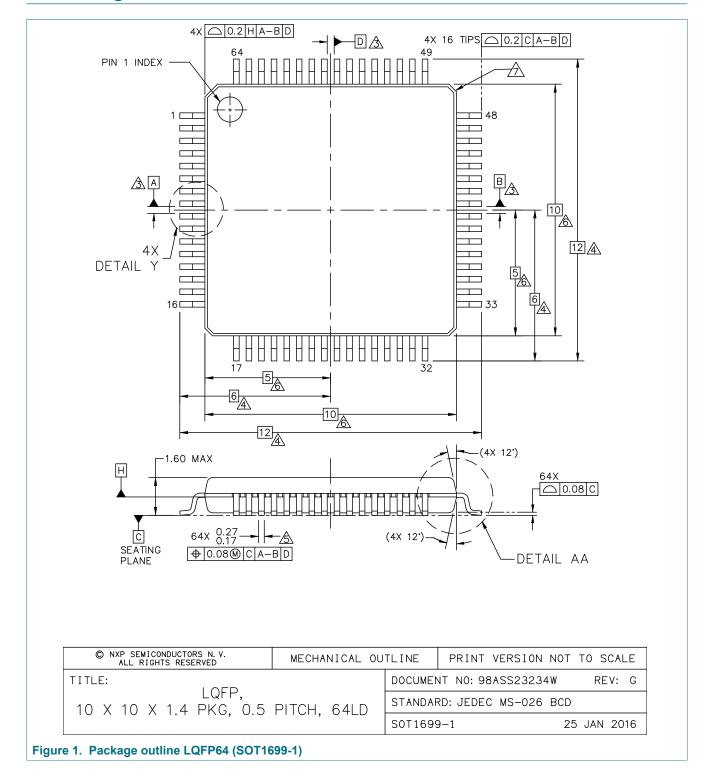
## Table 1. Package summary

Parameter	Min	Nom	Max	Unit
package length	-	10	-	mm
package width	-	10	-	mm
package height	-	1.4	-	mm
nominal pitch	-	0.5	-	mm
actual quantity of termination	-	64	-	

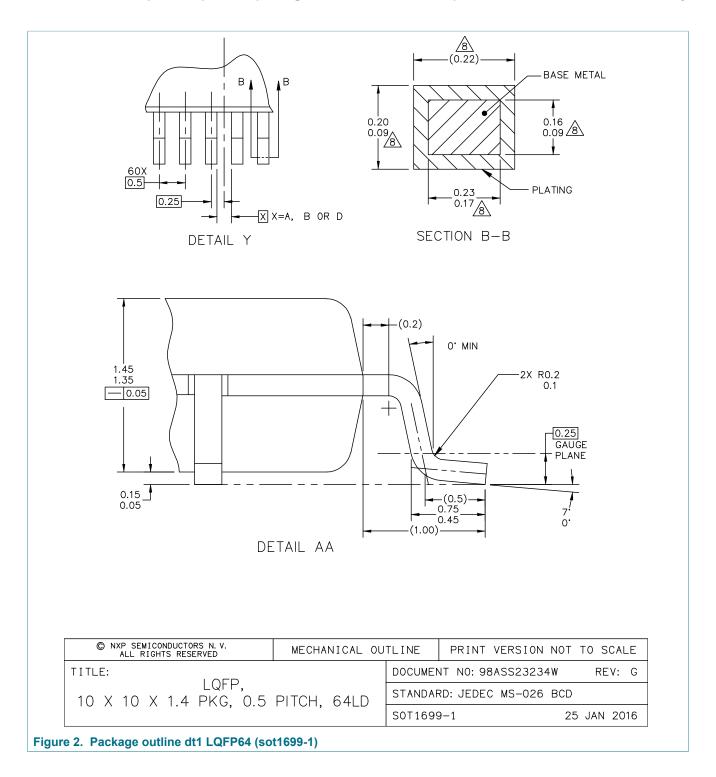


QFP64, plastic, quad flat package; 64 terminals; 0.5 mm pitch; 10 mm x 10 mm x 1.4 mm body

# 2 Package outline



QFP64, plastic, quad flat package; 64 terminals; 0.5 mm pitch; 10 mm x 1.4 mm body



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## NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- AT DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- $\triangle$  DIMENSIONS TO BE DETERMINED AT SEATING PLANE C.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE UPPER LIMIT BY MORE THAN 0.08 MM AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHALL NOT BE LESS THAN 0.07 MM.
- 6 THIS DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE. THIS DIMENSION IS MAXIMUM PLASTIC BODY SIZE DIMENSION INCLUDING MOLD MISMATCH.
- A EXACT SHAPE OF EACH CORNER IS OPTIONAL.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1 MM AND 0.25 MM FROM THE LEAD TIP.

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TITLE:		DOCUMEN	NT NO: 98ASS23234	W	REV: (	G
LQFP, 10 X 10 X 1.4 PKG, 0.5	PITCH, 64LD	STANDARD: JEDEC MS-026 BCD				
		S0T1699	9-1	25	JAN 2016	6

Figure 3. Package outline note LQFP64 (sot1699-1)

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# 3 Legal information

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